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## **PATENT**

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Salman Akram

Serial No.: 09/388,031

Filed: September 1, 1999

For: METALLIZATION STRUCTURES FOR SEMICONDUCTOR DEVICE INTERCONNECTS, METHODS FOR MAKING SAME, AND SEMICONDUCTOR DEVICES INCLUDING SAME

Examiner: To be assigned

**Group Art Unit: 2812** 

**Attorney Docket No.: 3442US (96-428)** 

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#### CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231.

August 1, 2000 Date of Deposit

Signature of registered practitioner or other person having reasonable basis to expect mailing to occuron date of deposit shown pursuant to 37 C.F.R. §1.8(a)(1)(ii)

Joseph A. Walkowski
Typed/printed name of person whose signature is contained above

# LETTER TO THE CHIEF DRAFTSMAN

Commissioner for Patents Washington, D.C. 20231

Sir:

Applicant submits herewith revised FIGS. 3a, 3b and 5 which correct errors in the drawings. Specifically, FIGS. 3a and 3b have been revised to add the reference numeral 100 with appropriate lead lines; and FIG. 5 has been revised to add the reference numeral 62a.

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## Serial No. 09/388,031

No new matter has been added. Approval of the proposed revisions is respectfully requested.

Respectfully submitted,

Joseph A. Walkowski Registration No. 28,765 Attorney for Applicant

TRASK BRITT P. O. Box 2550

Salt Lake City, Utah 84110-2550

Telephone: (801) 532-1922

Date: August 1, 2000

JAW/kf:dlm

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